ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoc nternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lower	level p	arts, the	declaration	on enco	mpasse	s all lower		erials for	which th	e item is an assembl ne manufacturer ha leclaration.		
1752-2 1.1	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x										on Class * RoHS Yes/No, Homogeneous Materials and Mfg Informa						
Supplier Information																	
Company Name *		Company Unique ID		Unique ID Authority Re			nse Date	*		Response Document ID							
Anaren Microwave						2021-)5-20										
Contact Name * Title - Contact				Phone - Contact *			- Contact	t *			D 15 4 -	0	۸ ډا .				
Herbert Jones	Project Engineer		315-233-551	0	herbert.jones@ttm.co			m	L	Duplicate	Contact -	ct -> Authorized Representative					
Authorized Representative * Title - Representative)	Phone - Representative *			- Represe	entative	*	Supplier Comments or URL for Additional Information								
Herbert Jones Project Engineer				315-233-5510			rt.jones@	ttm.co	m								
Requester Item Number		Mfr Item Number		Mfr Item Name		Effectiv	e Date	Version	sion Manufac		Site	Weight *	UC	DM	Unit Type		
		C6N50Z4				2021-0)5-20	A	East S	yracuse		0.002895	g		Each		
Alternate Recommend	ation							Alternate Item C				•			•		
Manufacturing Proces	ss In	formation															
Terminal Plating / Grid Array Material Termina			Terminal B	Base Alloy J-STD-020 MSL Ra			ating Peak Process Body Temp			perature Max Time at Peak Tem			perature Number of Reflow Cycles				
Matte Tin (Sn) - with Nickel (Ni) barrier Other				1		260			260 C		30 sec		3				
Comments Compliant to RoHS 2 Dir	ectiv	e 2011/65/FII of the	Furonear	Parliament :	and of the Counc	eil of 8	lune 201	1 & Con	nmissic	n Dele	agated Dir	rective 201	15/863/F	:II of 31	March 2015		

Save the fields in Import fields from a Clear all of the Lock the fields on this **Export Data** Import Data Reset Form Lock Supplier Fields this form to a file file into this form fields on this form form to prevent changes **RoHS Material Composition Declaration Declaration Type *** Detailed Rohs Directive Rohs Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenvls (PBB). Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium 2002/95/EC Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to suchpart shall apply. 1 - Item(s) does not contain RoHS restricted substances per the definition above Supplier Acceptance * Accepted **RoHS Declaration *** Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.

Decl	aration	Signature	
DCC	aration	Oignature	

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of		Level	Substance Cotegory			Substance	CAS		Mainb4	Unit of	Tolerance		PPM
	Name		Material	weight	Measure		Level	Substance Category			Substance	CAS	Exempt	Weight	Measure	-	+	PPIVI
+1 -1	C6N50Z4	+M -M	Part Marking Ink	0.00000	3g	+C -C	Supplier	Part Marking Ink	+S	-S	Titanium dioxide (TiO2)	13463-67-7		0.000002	g		8	357,10
						+C -C	Supplier	Part Marking Ink	+S	-S	Silica amorphous (SiO2	7631-86-9		0.000000	g		1	142,90
		+M -M	Protective Polym	0.00013	i g	+C -C	Supplier	Protective Polymer	+S	Ş	*Proprietary Metal Com	Proprietary		0.000013	g		1	100,00
						+C -C	Supplier	Protective Polymer	+S	-S	*Proprietary Blue Pigme	Proprietary		0.000027	g		2	200,00
						+C -C	Supplier	Protective Polymer	+S	-S	Cobalt (Co)	7440-48-4		0.000041	g		3	300,00
						+C -C	Supplier	Protective Polymer	+S	-S	Molybdenum (Mo)	7439-98-7		0.000054	g		4	400,00
		+M -M	Protective Glaze	0.00006	l g	+C -C	Supplier	Protective Glaze	+S	Ş	Boron Oxide (BO)	1303-86-2		0.000013	g		2	214,30
						+C -C	Supplier	Protective Glaze	+S	-s	Aluminum Oxide (Al2O3	1344-28-1		0.000004	g		6	64,300
						+C -C	Supplier	Protective Glaze	+S	-s	Silicon Dioxide (SiO2)	14808-60-7		0.000004	g		6	64,300
						+C -C	Supplier	Protective Glaze	+S	-S	Chromium(III) oxide (Cr	1308-38-9		0.000000	g		1	14,200
						+C -C	Supplier	Protective Glaze	+S	-S	Zinc oxide (ZnO)	1314-13-2		0.000041	g		6	642,90
		+M -M	Thick Film Resis	0.00004 ⁻	lg	+C -C	Supplier	Thick Film Resistor	+S	-S	Boron Oxide (BO)	1303-86-2		0.000005	g		1	134,60
						+C -C	Supplier	Thick Film Resistor	+S	-S	Magnesium Oxide (MgO	1309-48-4		0.000004	g		9	96,200
						+C -C	Supplier	Thick Film Resistor	+S	-S	Aluminum Oxide (Al2O3	1344-28-1		0.000005	g		1	134,60
						+C -C	Supplier	Thick Film Resistor	+S	-S	Silicon Dioxide (SiO2)	14808-60-7		0.000002	g		5	51,300
						+C -C	Supplier	Thick Film Resistor	+S	-S	Ruthenium(IV) dioxide (12036-10-1		0.000020	g		4	493,60
						+C -C	Supplier	Thick Film Resistor	+S	-S	Zinc oxide (ZnO)	1314-13-2		0.000003	g		8	89,700
		+M -M	Conductor	0.00021	J g	+C -C	Supplier	Conductor	+S	Ş	Silver (Ag)	7440-22-4		0.000191	g		9	910,00
						+C -C	Supplier	Conductor	+S	-S	Cobalt (Co)	7440-48-4		0.000003	g		1	15,000
						+C -C	Supplier	Conductor	+S	-S	Titanium (Ti)	7440-32-6		0.000015	g		7	75,000
		+M -M	Substrate	0.00225	2g	+C -C	Supplier	Substrate	+S	-S	Aluminum Nitride (ALN	24304-00-5		0.002140	g		9	950,00
						+C -C	Supplier	Substrate	+S	-S	Yttrium (III) oxide (Y2O3	1314-36-9		0.000112	g		5	50,000
		+M -M	Nickel Plating	0.00015	3g	+C -C	A	Lead/Lead Compound	+S	-S	Lead	7439-92-1		0.000000	g		2	499.75

		+C -C B	Nickel (external applic	+S ·	-S	Nickel	7440-02-0	0.000153	g		999,50
+M -M Tin Plating	0.000031g	+C -C Supplier	Tin Plating	+8 -	-s	Tin (Sn)	7440-31-5	0.000031	g		1,000,0